

## 強い層間交換結合を用いた STT-MRAM 向け垂直 SAF の作製

### Fabrication of p-SAF Structure with Strong Interlayer Exchange Coupling

産総研 ○薬師寺 啓, 久保田 均, 福島 章雄, 湯浅 新治

AIST ○K. Yakushiji, H. Kubota, A. Fukushima, and S. Yuasa

E-mail: k-yakushiji@aist.go.jp

A perpendicularly magnetized MgO-based magnetic tunnel junction (p-MTJ) is a promising candidate for use as a memory cell in spin-transfer-torque (STT) switching-type magnetoresistive random access memory (STT-MRAM). For steady read/write operations in a p-MTJ, the reference layer should have an identical magnetization direction for all memory cells, and a synthetic antiferromagnetic (SAF) structure has been widely applied. From the viewpoint of STT-MRAM applications, introducing the higher antiferromagnetic (AF) exchange coupling field of a perpendicularly magnetized SAF (p-SAF) structure has been considered preferable to prevent any read/write disturbance. SAF coupling manifests itself as a feature of the interlayer exchange coupling (IEC) effect through a thin spacer layer made of Ru, Rh, or Ir, for example. Its energy density ( $J_{\text{ex}}$ ) oscillates as a function of the spacer layer thickness. For Ru, Parkin et al. demonstrated that the highest  $J_{\text{ex}}$  occurred at the “first peak” of the oscillation, where the Ru thickness ( $t_{\text{Ru}}$ ) was less than 0.5 nm [1]. In the study, we fabricated [Co/Pt] superlattice [2] based p-SAF structures with  $t_{\text{Ru}}$  ranging from 0.34 to 1.05 nm to attain highly stable p-SAF structure with the 1<sup>st</sup> IEC peak.

We first fabricated p-SAF structures with the following stacked structure: Si-O substrate / Ta (5.0) / Ru (8.0) / Pt (2.0) / [Pt(0.16)/Co(0.24)]<sub>5</sub>(2.0) / Ru ( $t_{\text{Ru}}$ ) / [Co(0.24)/Pt(0.16)]<sub>5</sub> (2.0) / Pt(2.0) / capping (unit in nm), where  $t_{\text{Ru}}$  = 0.34–1.05 nm. We obtained large exchange field ( $H_{\text{ex}}$ ) of up to 10.0 kOe and 6.5 kOe, for the as-deposited and the annealed ( $T_{\text{a}}$  = 400°C, 1h) sample, respectively. The maximum  $J_{\text{ex}}$  was obtained at  $t_{\text{Ru}}$  = 0.43 to be 2.2 erg/cm<sup>2</sup>, which was three times higher than that at 0.95 nm (~0.7 erg/cm<sup>2</sup>). We also fabricated top-free-type p-MTJs with a newly developed p-SAF structure that exhibited strong AF coupling ( $T_{\text{a}}$  = 350°C, 1h). We attained a two-times-larger  $H_{\text{ex}}$  (~5.5 kOe) with a wide AF-coupled plateau compared with those of previous samples with a thicker Ru spacer corresponding to the 2<sup>nd</sup> peak [3]. At the same time, we achieved a high MR ratio of 150% at an RA product of 5.3  $\Omega\mu\text{m}^2$ . The use of p-SAF coupling at the 1<sup>st</sup> IEC peak is advantageous for achieving a highly stable reference layer for every STT-MRAM generation.

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#### References:

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